#### Guidelines for Choosing the Right Buck Regulator Control Strategy (Part B)

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#### **How Do You Choose?**

- Part A
  - Buck regulator basics
  - Fixed frequency control

#### Part B

- Variable frequency control
  - Constant on-time
  - Adaptive on-time
- TI D-CAP™ families
  - D-CAP2<sup>™</sup>
  - D-CAP3™
  - D-CAP+<sup>TM</sup>
- Conclusions



#### **Variable Frequency Control**



#### **Constant On-Time Control – Basic Operation**



#### **Adaptive On-Time Control – Frequency**



#### **COT Control – Transient Performance**



- D-CAP<sup>™</sup> mode: direct output capacitor voltage feedback
- D-CAP<sup>™</sup> mode does not have an error amplifier or compensation

#### **COT Control – Seamless DCM/CCM**



• The DCM/CCM transition is happening naturally without a mode change

## COT Control – High Efficiency @ Light Loads

#### **TPS53219 + CSD86350**

- Efficiency  $F_{SW}$  = 500 kHz, 12 V to 1.1 V
  - > 80% from 0.2 A to 25 A
  - > 55% efficiency in Skip mode at 10 mA



#### COT Control – External Components



VOUT



#### **TI D-CAP<sup>™</sup> Control Architecture**



• Adaptive constant on-time  $T_{ON} = -$ 

$$V_{\rm ON} = \frac{V_{\rm OUT}}{V_{\rm IN}} \times K$$

• Ramp is generated to improve the jitter performance

#### **COT Control – Ramp Compensation**

- Ramp compensation improves jitter performance by reducing the noise band
- Ramp compensation is built-in to most TI D-CAP controllers



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#### **TI D-CAP<sup>™</sup> – Ripple Requirements**



#### Without Series Resistor R<sub>c</sub>

With Sufficient R<sub>c</sub>

#### **TI D-CAP<sup>™</sup> – Stability Measurement**

- Conventional open-loop Bode plot measurement is not applied to COT control architecture since output is directly fed back to PWM modulator
- Closed-loop frequency measurement used to indicate stability issue
- Due to inherent load feed-forward capability, bandwidth measured from small-signal analyses will not indicate large-signal load transient performance

#### **TI D-CAP2<sup>™</sup> Control Architecture**



- Adaptive constant on-time  $T_{ON} = \frac{V_{OUT}}{V_{IN}} \times K$
- Ripple injection is added to D-CAP2<sup>™</sup>
- This allows stability with low output ripple and ceramic output capacitors

#### TI D-CAP2<sup>™</sup> – Output Accuracy in DCM/CCM







- Under deep DCM:  $V_{FB} \cong V_{REF}$ 

Offset is not constant in CCM and DCM

# **TI D-CAP2<sup>™</sup> – Duty Cycle Dependency**



- Fixed  $R_{C1}C_{C1}$  time constant = 30 µs for both outputs
- Transient performance is very different with different duty cycles

#### **TI D-CAP3<sup>™</sup> Control Architecture**



- All of the benefits of D-CAP2™
- Adaptive ripple algorithm changes  $R_{C1}C_{C1}$  time constant with  $V_{IN}$ ,  $V_{OUT}$  and  $I_{OUT}$
- Sample and hold circuit improves DC accuracy

#### **TI D-CAP3<sup>™</sup> – V<sub>OUT</sub> Accuracy**



• DC accuracy is improved in CCM operation

## **TI D-CAP3<sup>™</sup> – Adaptive Ripple Injection**



- Time constant for D-CAP2<sup>™</sup> = 30 µs
- Time constant for D-CAP3<sup>™</sup> = 120 µs
- Adaptive ripple algorithm changes RC time constant with V<sub>IN</sub>, V<sub>OUT</sub> and I<sub>OUT</sub>

#### **Multiphase DC-DC Converter – Introduction**



- Set of parallel converters
- Each power-stage is known as a *phase*
- The phases operate equally spaced through the period

#### Multiphase DC-DC Converter – **Output Ripple**

**Reduced output ripple current**  $\rightarrow$  Lower output capacitance to

maintain same voltage ripple



#### Multiphase DC-DC Converter – Input Ripple

Reduced switch current  $\rightarrow$  Distributed power loss and better thermal performance



Lower input RMS current  $\rightarrow$  Smaller capacitance, lower ESR power loss, reduced self heating

#### Multiphase DC-DC Converter – Load Transients

Improved transient with pulse overlap  $\rightarrow$  Lower output capacitance



- During load insertion, all the phases (N) are turned on
  - If L is the inductor of each phase, effective inductance is L/N
  - Ability to deliver current to the output capacitor is N times higher than single-phase

#### Multiphase DC-DC Converter – High Efficiency

#### **High Efficiency Over Wide Load Range**



- Dynamic phase management is integral to achieve high-efficiency over wide loading conditions
  - Higher load current, more phases
  - As load current is reduced, there is a trade-off between switching and conduction losses — dropping phases can optimize the efficiency
  - At extreme light load, the power supply transitions to single-phase discontinuous conduction mode (DCM)

#### **TI D-CAP+™ Control Architecture**



#### TI D-CAP+™ – Illustrated Transient Waveforms

Load Step-Up

Load Step-Down



- Pseudo constant switching frequency at steady state without internal clocks
- Variable switching frequency during load transients
- Dynamic current sharing during load transients

## TI D-CAP+™ – Dynamic Phase Shedding



- Phase adding/shedding is determined based on the instantaneous ISUM
- Consists of both current and time hysteresis for phase shedding

#### TI D-CAP+™ – Loop Gains with Different Phases

TPS53640 with 12  $V_{\text{IN}}$  to 1.7  $V_{\text{OUT}}$  @ 600 kHz, 10 A load and 1 m $\Omega$  loadline



Loop Gain is Insensitive to the Number of Phases

#### **TI D-CAP+™ – High Efficiency**

TPS53661 + CSD95372B with 12  $V_{\rm IN}$  to 1.8  $V_{\rm OUT}$  @ 600 kHz, 150 nH



#### **TI D-CAP+™ – Fast Phase Adding**

120 nH @ 500 kHz with 2x470  $\mu\text{F}/4.5$  m $\Omega$  + 8x22  $\mu\text{F}/\text{DIMM}$ 

LF RR @ 1 kHz, 50% duty cycle (@ sensing point) 14.2 A-59.5 A @ 11.3 A/µs





### **TI D-CAP+™ – Dynamic Current Sharing**

- Currents are amplified, filtered and compared with average current
- At each on-time, the on-time reference (DAC) is "tweaked" by a voltage equivalent to K x (I<sub>IN</sub> - I<sub>AVG</sub>)
- Since filtering is light (5 μs), system response is < 25 μs</li>
- Current sharing loop analysis paper is available on request



#### **TI D-CAP+™ – Dynamic Current Sharing**



(1 A to 100 A @ 600 A/µs and Load Frequency = Switching Frequency)



#### **Comparisons of TI D-CAP™ Families**

Control Architecture	Features
D-CAP™	<ul> <li>Adaptive on-time control</li> <li>Fast load transient response</li> <li>Ramp compensation built-in</li> <li>High efficiency @ light loads</li> </ul>
D-CAP2 <sup>TM</sup>	Internal ripple compensation for MLCCs
D-CAP3™	<ul> <li>Sample-and-hold for DC accuracy improvement for CCM/DCM</li> <li>Adaptive ripple compensation</li> </ul>
D-CAP+ <sup>TM</sup>	<ul> <li>With actual current feedbacks</li> <li>Extension to multi-phase applications</li> <li>Dynamic current sharing</li> <li>Dynamic phase shedding</li> </ul>

## **COT Control – Advantages and Challenges**

Advantages	Disadvantages	
Simple design, no compensation required	Variable switching frequency (Solution: D-CAP/D-CAP2/D-CAP3/D- CAP+)	
Excellent load transient response	Sensitive to PCB design for jitter (Solution: D-CAP/D-CAP2/D-CAP3/D- CAP+)	
Excellent line transient response	Minimum ripple requirement or output capacitor type limitations (Solution: D-CAP2/D-CAP3/D-CAP+)	
Seamless DCM/CCM transitions for good light-load efficiency	Poor load/line regulation (Solution: D-CAP3/D-CAP+)	
	Not easy for multi-phase configurations (Solution: D-CAP+)	

#### Design Example #3 COT Control – Design Specifications

Design Specifications				
Input voltage range	5 V to 18 V			
Target output voltage	1.2 V			
Output current range	0 A to 6.6 A			
Switching frequency	500 kHz			
Controller	TPS53515			



#### Design Example #3 COT Control – Performance Graph



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#### **Switching Operation**



#### Design Example #4 D-CAP+ Design Specifications

Design Specifications				
Input voltage range	12 V			
Target output voltage	1.6 V-1.9 V			
Output current range	0 A to 189 A			
Switching frequency	600 kHz			
Controller	TPS53641			

1.61



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## **Design Example #4** D-CAP+ Performance Graph

12 V to 1.8 V with 4-phase operations @ 600 kHz, 150 nH, and 1 m $\Omega$  loadline



# **Design Example #4** D-CAP+ Performance Graph (2)

12 V to 1.8 V with 4-phase operations @ 600 kHz, 150 nH, and 1 m $\Omega$  loadline



1 µs/div

Dynamic Voltage Change (1.6 V to 1.82 V @ 5 A)



20 µs/div



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